onsemi

<u>MOSFET</u> - SiC Power, Single N-Channel, TO247-4L 650 V, 70 mΩ, 31 A

NTH4L095N065SC1

Features

- Typ. $R_{DS(on)} = 70 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$ Typ. $R_{DS(on)} = 95 \text{ m}\Omega @ V_{GS} = 15 \text{ V}$
- Ultra Low Gate Charge ($Q_{G(tot)} = 50 \text{ nC}$)
- Low Output Capacitance (C_{oss} = 89 pF)
- 100% Avalanche Tested
- $T_J = 175^{\circ}C$
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storage

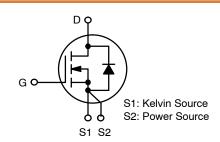
MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	650	V	
Gate-to-Source Voltage	Gate-to-Source Voltage		V _{GS}	-8/+22	V
Recommended Operation Values of Gate-to-Source Voltage		T _C < 175°C	V _{GSop}	-5/+18	V
Continuous Drain Current (Note 1)	Steady State	$T_C = 25^{\circ}C$	۱ _D	31	A
Power Dissipation (Note 1)			PD	129	W
Continuous Drain Current (Note 1)	Steady State	T _C = 100°C	۱ _D	22	A
Power Dissipation (Note 1)			PD	64	W
Pulsed Drain Current (Note 2)	$T_{C} = 25^{\circ}C$		I _{DM}	97	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			I _S	26	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)}$ = 9.4 A, L = 1 mH) (Note 3)			E _{AS}	44	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)		ΤL	260	°C	

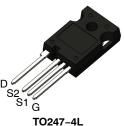
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. EAS of 44 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 9.4 A, V_{DD} = 50 V, V_{GS} = 18 V.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
650 V	105 mΩ @ 18 V	31 A	

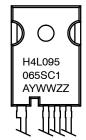


N-CHANNEL MOSFET



CASE 340CJ

MARKING DIAGRAM



H4L095065SC1 = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NTH4L095N065SC1	TO247-4L	30 Units / Tube

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 1)	$R_{ ext{ heta}JC}$	1.16	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

- - 10 1 250 4.3 +18 - 105 - - -	V V/°C μA mA nA V V V S
- 10 1 250 4.3 +18 - 105 -	V/°C μA mA nA V V V
1 250 4.3 +18 - 105 -	μA mA nA V V mΩ
1 250 4.3 +18 - 105 -	mA nA V V mΩ
250 4.3 +18 - 105 -	nA V V mΩ
4.3 +18 - 105 -	V V mΩ
+18 - 105 -	V mΩ
+18 - 105 -	V mΩ
- 105 -	mΩ
105 -	
-	S
	S
-	S
· · · · · ·	
·	
-	pF
_	
_	
_	nC
_	
_	
_	Ω
I	
-	ns
_	
-	
- 1	μJ
-	
	1
L1	
26	A
	-

 V_{GS} = –5 V, I_{SD} = 12 A, T_J = 25°C

4.5

_

V

_

 V_{SD}

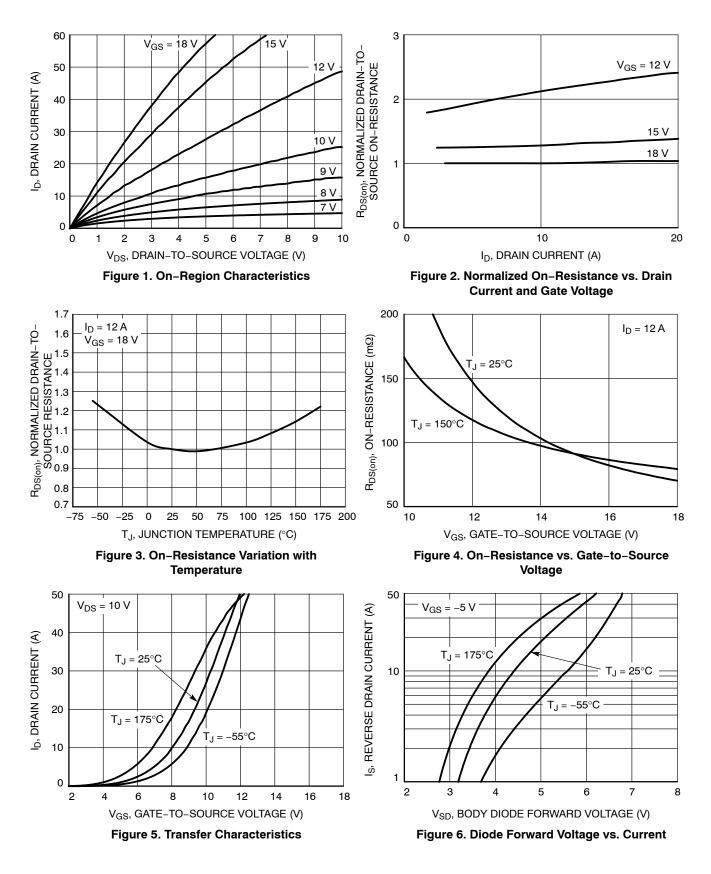
Forward Diode Voltage

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

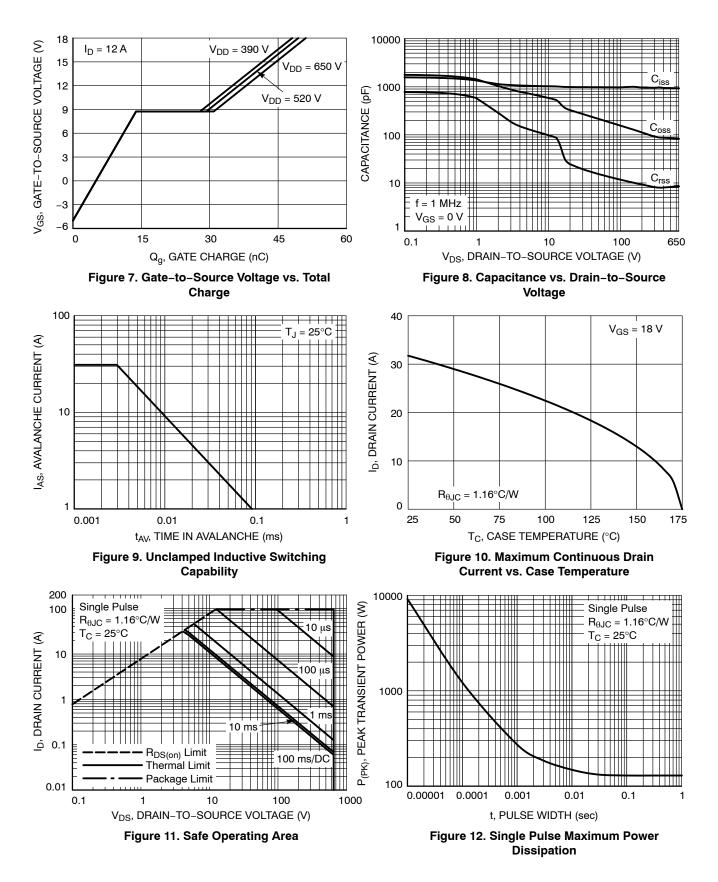
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	V _{GS} = -5/18 V, I _{SD} = 12 A, dI _S /dt = 1000 A/μs	-	15	-	ns	
Reverse Recovery Charge	Q _{RR}		-	62	-	nC	
Reverse Recovery Energy	E _{REC}		-	6.5	-	μJ	
Peak Reverse Recovery Current	I _{RRM}		-	8	-	А	
Charge time	Та		-	8	-	ns	
Discharge time	Tb]	-	7	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

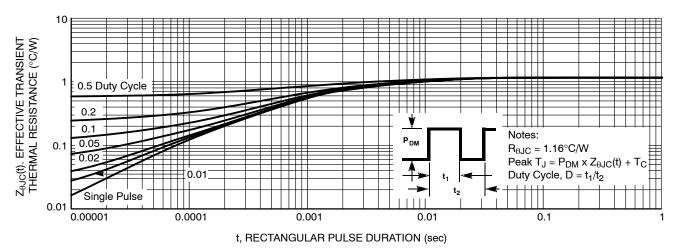


Figure 13. Junction-to-Case Thermal Response



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

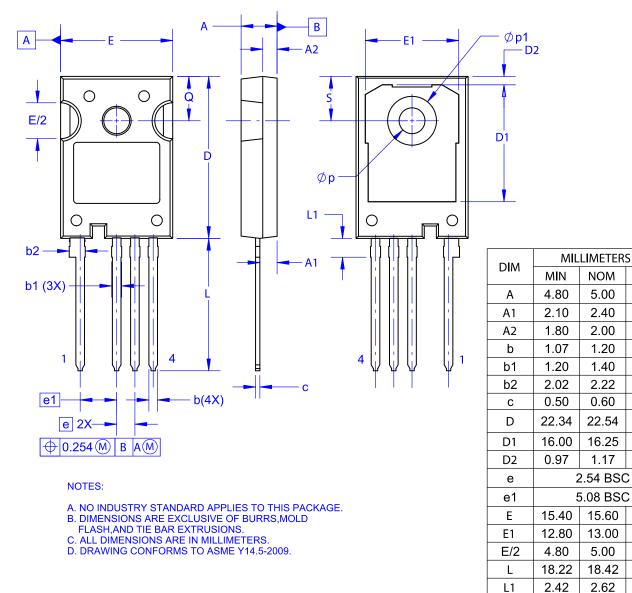
18.62

2.82

3.80

7.00 6.37

6.37



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